505228846 12/10/2018

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2

EPAS ID: PAT5275616

SUBMISSION TYPE:	CORRECTIVE ASSIGNMENT
NATURE OF CONVEYANCE:	Corrective Assignment to correct the THE PRIORITY INFORMATION LISTED IN THE ASSIGNMENT DOCUMENT previously recorded on Reel 039312 Frame 0283. Assignor(s) hereby confirms the ADDITION OF PRIORITY US APPLICATION NO. 62/337,579 FILED MAY 17, 2016 TO THE REVISED ASSIGNMENT.
RESUBMIT DOCUMENT ID:	504948025

CONVEYING PARTY DATA

Name	Execution Date
JUN TAN	11/09/2016

RECEIVING PARTY DATA

Name:	QUALCOMM INCORPORATED
Street Address:	5775 MOREHOUSE DRIVE
City:	SAN DIEGO
State/Country:	CALIFORNIA
Postal Code:	92121-1714

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	15187710

CORRESPONDENCE DATA

Fax Number: (214)200-0853

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 2146515000

Email: ipdocketing@haynesboone.com HAYNES AND BOONE, LLP Correspondent Name:

Address Line 1: 2323 VICTORY AVENUE, SUITE 700

DALLAS, TEXAS 75219 Address Line 4:

ATTORNEY DOCKET NUMBER:	36340.513US01 156888
NAME OF SUBMITTER:	KATARINA CUVALO
SIGNATURE:	/Katarina Cuvalo/
DATE SIGNED:	12/10/2018

Total Attachments: 4

source=36340.513US01 156888 Original Confirmation Receipt for filed Assignment for 15187710#page1.tif source=36340.513US01 156888 Original Confirmation Receipt for filed Assignment for 15187710#page2.tif

PATENT REEL: 048127 FRAME: 0242 505228846

source=36340.513US01 156888 Corrective Assignment#page1.tif source=36340.513US01 156888 Corrective Assignment#page2.tif

PATENT REEL: 048127 FRAME: 0243



United States Patent and Trademark Office

Home | Site Index | Search | Guides | Contacts | eBusiness | eBiz alerts | News | Hain



Electronic Patent Assignment System

Confirmation Receipt

Your assignment has been received by the USPTO. The coversheet of the assignment is displayed below:

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
JUN TAN	08/01/2016

RECEIVING PARTY DATA

Name:	QUALCOMM INCORPORATED
Street Address:	5775 MOREHOUSE DRIVE
City:	SAN DIEGO
State/Country:	CALIFORNIA
Postal Code:	92121-1714

PROPERTY NUMBERS Total: 2

Property Type	Number
Application Number:	15187710
Application Number:	62269811

CORRESPONDENCE DATA

Fax Number: (214)200-0853 **Phone**: 214-651-5000

Email: ipdocketing@haynesboone.com

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax

number, if provided; if that is unsuccessful, it will be sent via US Mail.

Correspondent Name: HAYNES AND BOONE, LLP IP SECTION

Address Line 1: 2323 VICTORY AVENUE

Address Line 2: SUITE 700

Address Line 4: DALLAS, TEXAS 75219

NAME OF SUBMITTER:	GARY J. EDWARDS
Signature:	/Gary J. Edwards/
Date:	08/02/2016

Total Attachments: 2

source=36340-513US01_156888_2016_08_01_Assignment_for_15187710#page1.tif source=36340-513US01_156888_2016_08_01_Assignment_for_15187710#page2.tif

RECEIPT INFORMATION

EPAS ID: PAT3988223 **Receipt Date**: 08/02/2016

Return to home page

| .HOME | INDEX | SEARCH | @BUSINESS | CONTACT US | PRIVACY STATEMENT

PATENT

ASSIGNMENT

WHEREAS, I, Jun Tan, a citizen of Singapore, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121; and a resident of San Diego, have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to MULTIMODE VOLTAGE CONTROLLED OSCILLATOR (collectively the "INVENTIONS") for which I have executed and/or may execute one or more patent applications therefor; and

WHEREAS, QUALCOMM Incorporated (hereinafter "ASSIGNEE"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, I do hereby acknowledge that I have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, including but not limited to U.S. Application No(s). 15/187,710 filed June 20, 2016, Qualcomm Reference No.156888, and all provisional applications relating thereto, including U.S. Application No. 62/269,811 filed December 18, 2015, Qualcomm Reference No. 156888P1, U.S. Application No. 62/337,579 filed May 17, 2016, Qualcomm Reference No. 156888P2 (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States:

AND I further do acknowledge and agree that I have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

PATENT REEL: 048127 FRAME: 0246 AND I DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND I DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which I may be entitled, or that I may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND I HEREBY covenant and agree that I will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to me respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

AND I HEREBY covenant that I will not execute any writing or do any act whatsoever conflicting with these presents.

Done at Sun Diego, on Nov. 9, 2016

LOCATION DATE

Jun Tan

PATENT REEL: 048127 FRAME: 0247

RECORDED: 06/06/2018